

## 20V N-Channel Enhancement Mode MOSFET

### DESCRIPTION

The STN2300 is the N-Channel logic enhancement mode power field effect transistor is produced using high cell density. advanced trench technology to provide excellent  $R_{DS(ON)}$ . low gate charge and operation gate as 1.8V.

This device is suitable for use as a load switch or other general applications.

*STN2300S-TRG ROHS Compliant This is Halogen Free*

### FEATURE

- ◆  $20V/4.0A, R_{DS(ON)} = 22m\Omega(typ.)@V_{GS} = 4.5V$
- ◆  $20V/3.0A, R_{DS(ON)} = 27m\Omega(typ.)@V_{GS} = 2.5V$
- ◆  $20V/2.0A, R_{DS(ON)} = 37m\Omega(typ.)@V_{GS} = 1.8V$
- ◆ Super high density cell design for extremely low Gate Charge
- ◆ Exceptional on-resistance and Maximum DC current capability

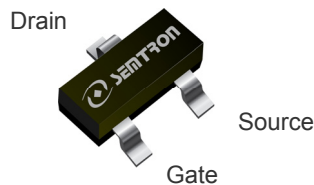
### APPLICATIONS

- ◆ Power Management in Note book
- ◆ Portable Equipment
- ◆ Load Switch

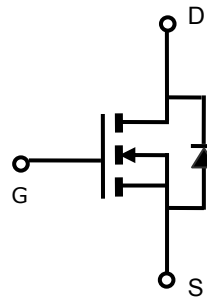


N-Channel Enhancement Mode MOSFET

### PIN CONFIGURATION



SOT-23  
Top View



### PART NUMBER INFORMATION

$\frac{\text{ST}}{\text{a}} \frac{\text{N}}{\text{b}} \frac{\text{2300}}{\text{c}} \frac{\text{S}}{\text{d}} - \frac{\text{TR}}{\text{e}} \frac{\text{G}}{\text{f}}$	<p>a : Company name.  b : Channel type.  c : Product Serial number.  d : Package code  e : Handling code  f : Green product code</p>
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## ORDERING INFORMATION

Part Number	Package Code	Handling Code	Shipping
STN2300S-TRG	S : SOT-23	TR : Tape&Reel	3K/Reel

- ※ Year Code : 0 ~ 9, 2010 : 0
- ※ Week Code : A(1~2) ~ Z(53~54)
- ※ SOT-23 : Only available in tape and reel packaging.

## ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> = 25°C Unless otherwise noted )

Symbol	Parameter	Typical	Unit
V <sub>DSS</sub>	Drain-Source Voltage	20	V
V <sub>GSS</sub>	Gate-Source Voltage	±12	V
I <sub>D</sub>	Continuous Drain Current (T <sub>C</sub> =25°C) <sup>A</sup>	V <sub>GS</sub> =4.5V	4
	Continuous Drain Current (T <sub>C</sub> =70°C) <sup>A</sup>		3.2
I <sub>DM</sub>	Pulsed Drain Current <sup>B</sup>	20	A
P <sub>D</sub>	Power Dissipation	T <sub>A</sub> =25°C	1.0
		T <sub>A</sub> =70°C	0.7
T <sub>J</sub>	Operation Junction Temperature	-55 to 150	°C
T <sub>STG</sub>	Storage Temperature Range	-55 to 150	°C

Note: Absolute maximum ratings are those values beyond which the device could be permanently damaged.  
 Absolute maximum ratings are stress ratings only and functional device operation is not implied.

## THERMAL DATA

Symbol	Parameter	Typ	Max	Unit	
R <sub>θJA</sub>	Thermal Resistance-Junction to Ambient <sup>A</sup>	Steady-State	-	125	°C/W
R <sub>θJC</sub>	Thermal Resistance Junction to Lead <sup>A</sup>	Steady-State	-	85	°C/W

## ELECTRICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ Unless otherwise noted)

Symbol	Parameter	Condition	Min	Typ	Max	Unit
<b>Static Parameters</b>						
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	20			V
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	0.4		1.0	V
$I_{GSS}$	Gate Leakage Current	$V_{DS}=0V, V_{GS}=\pm 12V$			$\pm 100$	nA
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS}=20V, V_{GS}=0V$			1	$\mu A$
		$V_{DS}=20V, V_{GS}=0V$ $T_J=55^\circ\text{C}$			5	
$R_{DS(ON)}$	Drain-source On-Resistance <sup>B</sup>	$V_{GS}=4.5V, I_D=4.0A$		22	26	m $\Omega$
		$V_{GS}=2.5V, I_D=3.0A$		27	32	
		$V_{GS}=1.8V, I_D=2.0A$		37	45	
$G_{fs}$	Forward Transconductance	$V_{DS}=5V, I_D=2A$		6.5		S
<b>Source-Drain Diode</b>						
$V_{SD}$	Diode Forward Voltage	$I_S=1.0A, V_{GS}=0V$		0.7	1.2	V
$I_S$	Continuous Source Current <sup>AD</sup>				5.6	A
<b>Dynamic Parameters</b>						
$Q_g$	Total Gate Charge	$V_{DS}=10V$ $V_{GS}=4.5V$ $I_D=4.0A$		6.2		nC
$Q_{gs}$	Gate-Source Charge			0.73		
$Q_{gd}$	Gate-Drain Charge			3.3		
$C_{iss}$	Input Capacitance	$V_{DS}=10V$ $V_{GS}=0V$ $f=1\text{MHz}$		440		pF
$C_{oss}$	Output Capacitance			116		
$C_{rss}$	Reverse Transfer Capacitance			94		
$t_{d(on)}$	Turn-On Time	$V_{DD}=10V$ $I_D=4.0A$		4.8		nS
$t_r$				14.5		
$t_{d(off)}$	Turn-Off Time	$V_{GEN}=4.5V$ $R_G=3.3\Omega$		25		
$t_f$				14		

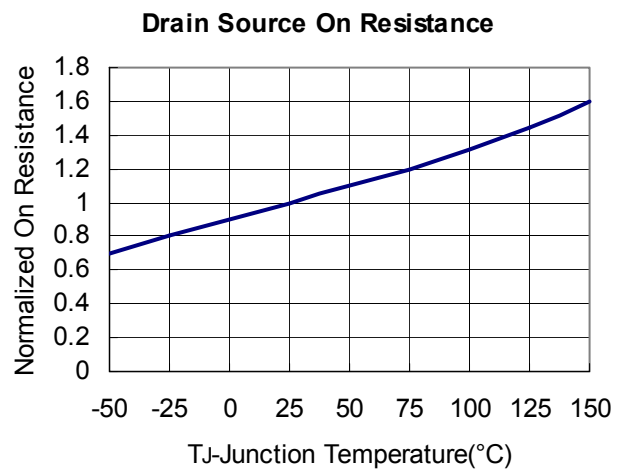
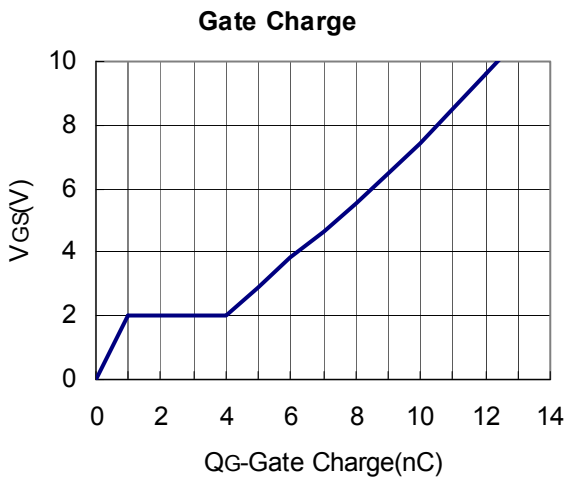
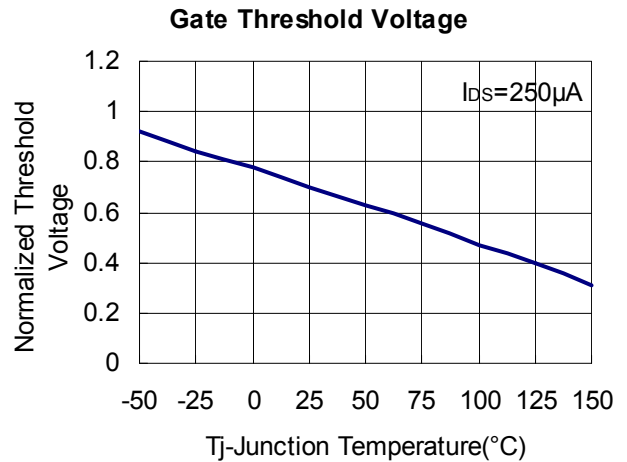
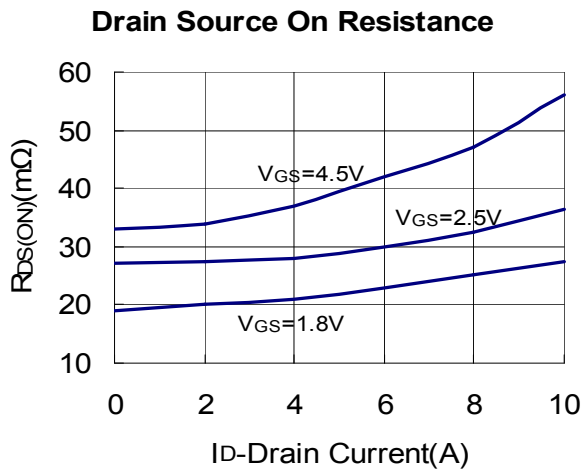
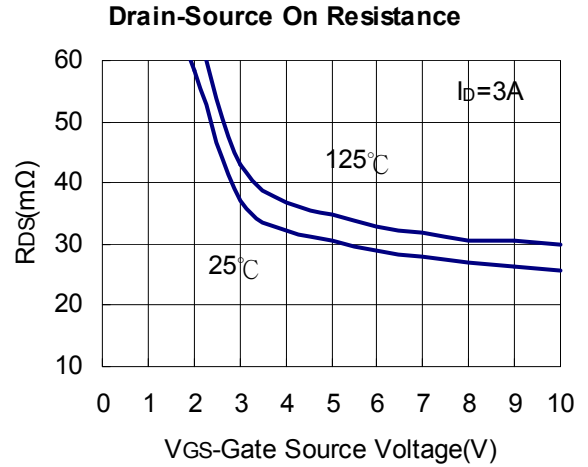
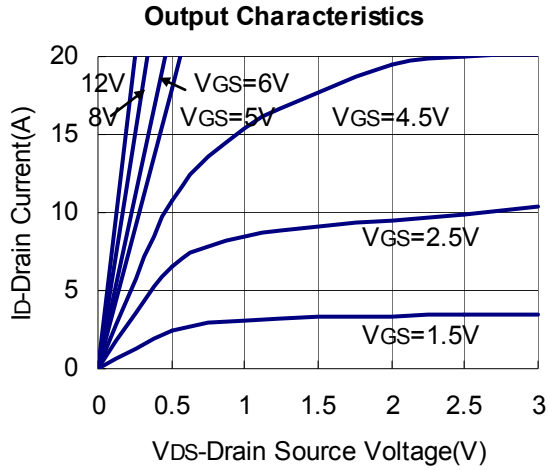
Note:

- The value of  $R_{\theta JA}$  is measured with the device mounted on 1in 2 FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^\circ\text{C}$ .
- The data tested by pulsed, pulse width  $\leq 300\mu\text{s}$ , duty cycle  $\leq 2\%$
- The EAS data shows Max. rating. The test condition is  $V_{DD}=-25V, V_{GS}=-10V, L=0.1\text{mH}$ .
- The data is theoretically the same as  $I_D$  and  $I_{DM}$ , in real applications, should be limited by total power dissipation.

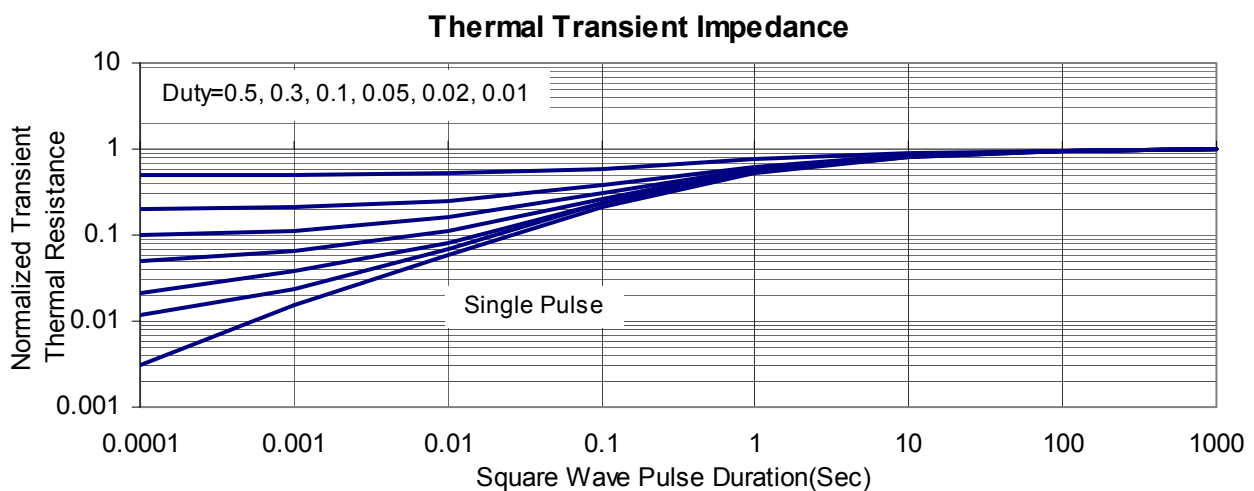
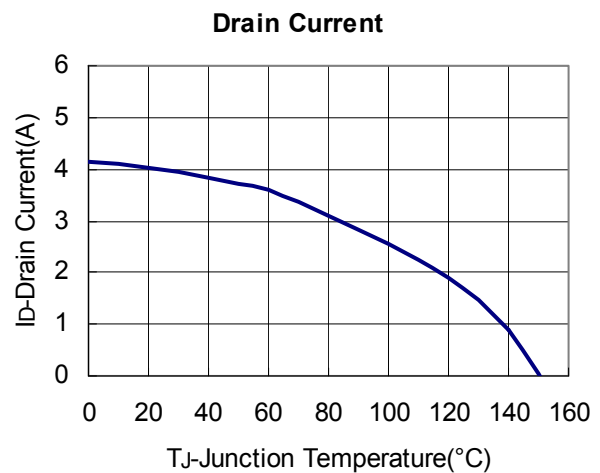
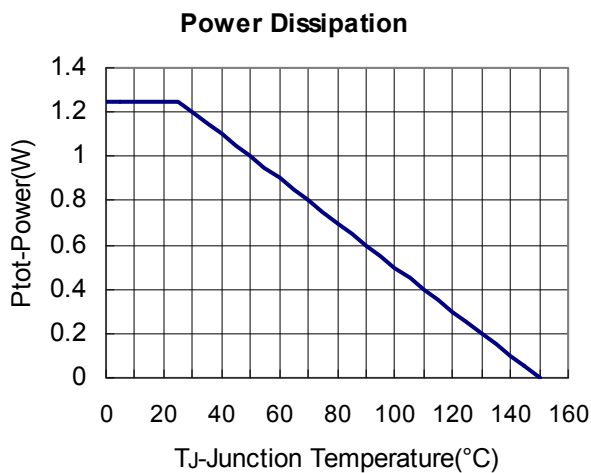
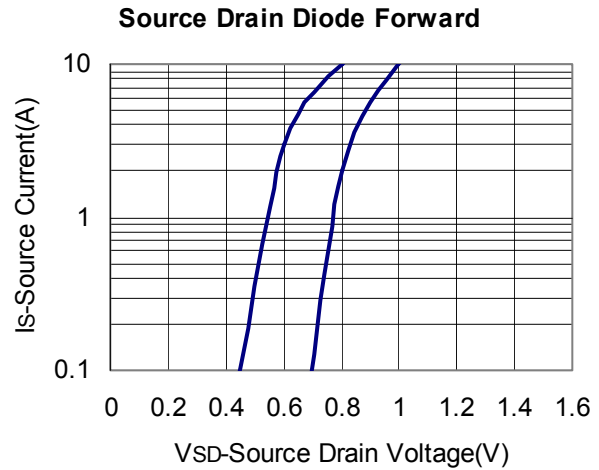
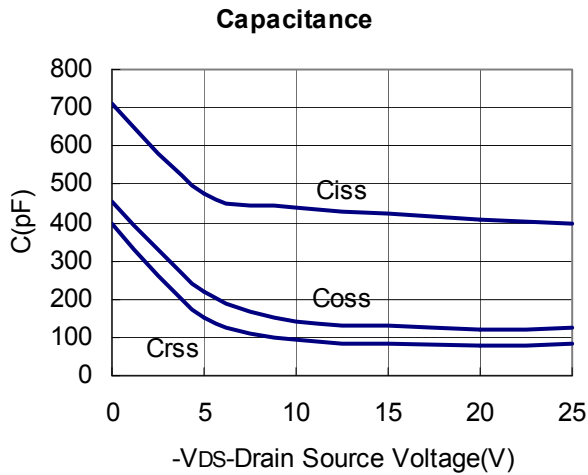
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## TYPICAL CHARACTERISTICS



## TYPICAL CHARACTERISTICS



## SOT-23 PACKAGE DIMENSIONS

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
c	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
e	0.950 TYP.		0.037 TYP	
e1	1.800	2.000	0.071	0.079
L1	0.550 REF.		0.022 REF.	
L1	0.300	0.500	0.012	0.020
$\theta$	0°	8°	0°	8°

